

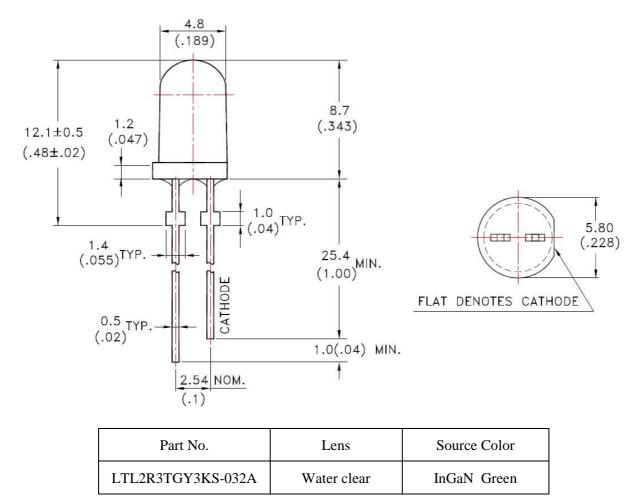
### LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

#### Features

- \* High luminous intensity output.
- \* Low power consumption.
- \* High efficiency.
- \* Versatile mounting on P.C. board or panel.
- \* I.C. Compatible/low current requirements.
- \* Popular T-13/4 diameter.
- \* Lead (Pb) free product RoHS compliant.

#### **Package Dimensions**



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25$ mm(.010") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

Part No.: LTL2R3TGY3KS-032A

Page: 1 of 11



Property of Lite-On Only

Parameter	Maximum Rating	Unit		
Power Dissipation	105	mW		
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA		
DC Forward Current	30	mA		
Derating Linear From 30°C	0.45	mA/°C		
Operating Temperature Range	-30°C to + 85°C			
Storage Temperature Range	-40°C to + 100°C	-40°C to + 100°C		
Lead Soldering Temperature [2.0 mm(.078") From Body]	260°C for 5 Seconds 1	260°C for 5 Seconds Max.		



### LITE-ON TECHNOLOGY CORPORATION

#### Property of Lite-On Only

#### BNS-OD-C131/A4

#### Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	7800		16000	mcd	IF = 20mA Note 1,5
Viewing Angle	2 <del>0</del> 1/2		30		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λp		531		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	525		532	nm	Note 3
Spectral Line Half-Width	Δλ		35		nm	
Forward Voltage	VF	2.8		3.3	V	$I_F = 20 m A$
Reverse Current	IR			20	μΑ	$V_R = 5V$ , Note 8

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength,  $\lambda d$  is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Iv classification code is marked on each packing bag.
- 5. The Iv guarantee should be added  $\pm 15\%$  tolerance.
- 6. Precautions in handling:

When soldering, leave 2mm of minimum clearance from the resin to the soldering point.

- Dipping the resin to solder must be avoided.
- Correcting the soldered position after soldering must be avoided.

In soldering, do not apply any stress to the lead frame particularly when heated.

When forming a lead, make sure not to apply any stress inside the resin.

Lead forming must be done before soldering.

It is necessary to cut the lead frame at normal temperature.

7. Caution in ESD:

Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

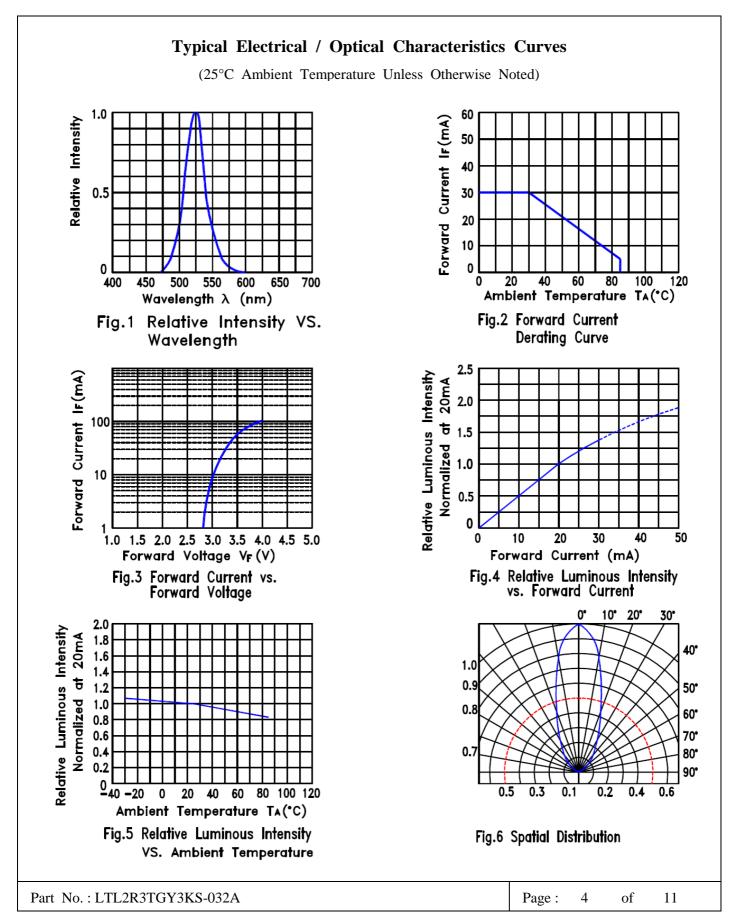
8. Reverse voltage( $V_R$ ) condition is applied for IR test only. The device is not designed for reverse operation.

Part No.: LTL2R3TGY3KS-032A



### LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only



## LITEON

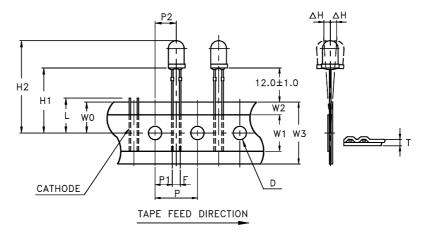
### LITE-ON TECHNOLOGY CORPORATION

#### Property of Lite-On Only

#### Features

- \* Compatible with radial lead automatic insertion equipment.
- \* Most radial lead plastic lead lamps available packaged in tape and folding.
- \* 2.54mm (0.1") straight lead spacing available.
- \* Folding packaging simplifies handling and testing. Reel packaging is available by removing suffix "A" on option.

### Package Dimensions

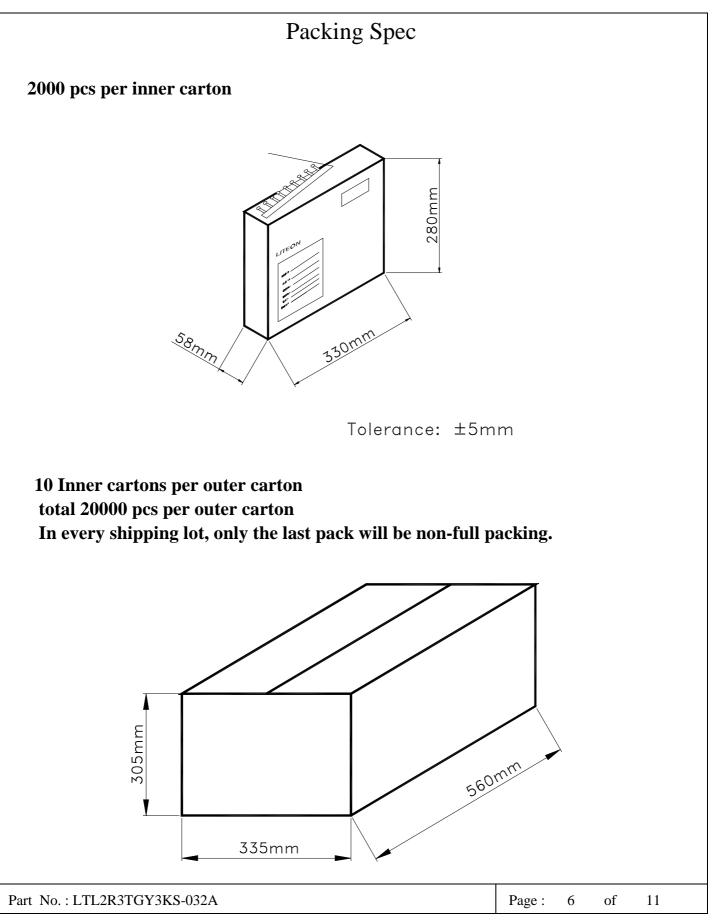


		Speci	Specification		
Item	Symbol	Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165
Component Lead Pitch	F	2.3	0.091	3.0	0.118
Front to Rear Deflection	∆H			2.0	0.078
Feed Hole to Bottom of Component	H1	20.0	0.787	21.0	0.827
Feed Hole to Overall Component Height	H2	28.4	1.118	30.0	1.181
Lead Length After Component Height	L	V	V0	11.0	0.433
Feed Hole Pitch	Р	12.4	0.488	13.0	0.511
Lead Location	P1	4.4	0.173	5.8	0.228
Center of Component Location	P2	5.05	0.198	7.65	0.301
Total Tape Thickness	Т			0.90	0.035
Feed Hole Location	W0	8.5	0.334	9.75	0.384
Adhesive Tape Width	W1	14.5	0.571	15.5	0.610
Adhesive Tape Position	W2	0	0	3.0	0.118
Tape Width	W3	17.5	0.689	19.0	0.748
		1	1	<u>I</u>	1
rt No. : LTL2R3TGY3KS-032A			Page :	5 0	f 11

NS-OD-C131/A4



Property of Lite-On Only



BNS-OD-C131/A4



#### Property of Lite-On Only

Luminous Intensity Unit : mcd @20mA					
Bin Code	Min.	Max.			
А	7800	9600			
В	9600	12500			
С	12500	16000			

#### **Bin Table Specifications**

Note: Tolerance of each bin limit is  $\pm 15\%$ 

Dominant Wa	avelength Unit:	nm @20 mA /25 °C
Bin Code	Min.	Max.
G1	525	527
G2	527	530
G3	530	532

Note: Tolerance of each bin limit is  $\pm 1$ nm

# **LITEO**NI

### LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

### CAUTIONS

#### 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

#### 4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

#### 5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions :

Soldering iron		Wave soldering		
Temperature Soldering time	350°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

Part No. : LTL2R3TGY3KS-032A

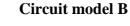
Page: 8 of 11

**Property of Lite-On Only** 

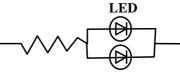
#### 6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A







- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

#### 7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

## LITEON

### LITE-ON TECHNOLOGY CORPORATION

#### Property of Lite-On Only

Suggested checking list :

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

#### Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: \*50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?



#### Property of Lite-On Only

Classification	Test Item	Test Condition	Sample Size	Reference Standard
	Operation Life	Ta = 25°C IF = 30mA *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
	High Temperature/ High Humidity storage (THB)	Ta = 85℃ RH = 85% *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
Endurance	Steady state Operation Life of High Humidity Heat	Ta = 85℃, RH= 85 % IF = 10 mA *Test Time= 500hrs	76 PCS (CL=90%; LTPD=3%)	JESD22-A101C (2009)
Test	Low Temperature Operation Life of	Ta = -30℃ IF = 30mA *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	
	High Temperature Storage	Ta= 105 ± 5℃ 45 PCS   *Test Time= 1000hrs (CL=90%; LTPD=5%)	(CL=90%;	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low Temperature Storage	Ta= -55 ± 5℃ *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	JEITA ED-4701:200 202 (2001)
	Temperature Cycling	$100^{\circ}$ $\sim 25^{\circ}$ $\sim -40^{\circ}$ $\sim 25^{\circ}$ 30mins 5mins 30mins 5mins *Test time: 200 Cycles	76 PCS (CL=90%; LTPD=3%)	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal Shock	$100 \pm 5^{\circ}$ ~ -30^{\circ}C \pm 5^{\circ}C15mins15mins*Test time: 200 Cycles(<20 secs transfer)	76 PCS (CL=90%; LTPD=3%)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
Resist	Solder Resistance	T.sol = $260 \pm 5$ °C Dwell Time= $10\pm 1$ seconds 3mm from the base of the epoxy bulb	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2031(1995) JEITA ED-4701: 300 302 (2001
	Solderability	T. sol = $245 \pm 5$ °C Dwell Time= $5 \pm 0.5$ seconds (Lead Free Solder, Coverage $\ge 95$ % of the dipped surface)	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron	T. sol = $350 \pm 5$ °C Dwell Time= $3.5 \pm 0.5$ seconds	11 PCS (CL=90%;LTPD= 18.9%)	MIL-STD-202G:208H (2002) JEITA ED-4701:300 302 (2001)

#### 9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

Part No. : LTL2R3TGY3KS-032A

11 of Page : 11

### **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard LEDs - Through Hole category:

Click to view products by Lite-On manufacturer:

Other Similar products are found below :

LTL-10254W LTL-1214A LTL-3251A LTL-4262N LTL-433P LTL-5234 LTL87HTBK LTW-87HD4B HLMP-EL30-PS0DD 1L0532V23G0TD001 NSPW500CS NTE30036 NTE30044 NTE30059 NTE3020 LD CQDP-1U3U-W5-1-K LO566UHR3-70G-A3 LP379PPG1C0G0300001 SLX-LX3044GD SLX-LX3044ID SLX-LX3044YD 1.90690.3330000 SSS-LX4673ID-410B 1L0532Y24I0TD001 264-7SYGD/S530-E2 HLMP-1301-G00FG HLMP1385 LTL-10224W LTL-1224A LTL-1234A LTL-2251AT LTL-403HR LTL-4222 LU7-E-B 4380H1 TLHY44K1L2 HLMP-3962-F0002 HLMP-GG15-R0000 323-2SURD/S530-A3 L53SRC/E-Z L-7679C1ZGC 4302T1-5V 4306D23 4363D1/5 WP1503SRC/J4 WP153GDT WP153YDT WP1543SGC WP1543SURC WP53MGD